

QL3025 - pASIC 3 FPGA™



25,000 Usable PLD Gate pASIC 3 FPGA Combining High Performance and High Density

DEVICE HIGHLIGHTS

High Performance & High Density

- 25,000 Usable PLD Gates with 204 I/Os
- 16-bit counter speeds over 300 MHz, data path speeds over 400 MHz
- 0.35µm four-layer metal non-volatile CMOS process for smallest die sizes

Easy to Use / Fast Development Cycles

- 100% routable with 100% utilization and complete pin-out stability
- Variable-grain logic cells provide high performance and 100% utilization
- Comprehensive design tools include high quality Verilog/VHDL synthesis

Advanced I/O Capabilities

- Interfaces with both 3.3 volt and 5.0 volt devices
- PCI compliant with 3.3V and 5.0V buses for -1/-2/-3/-4 speed grades
- Full JTAG boundary scan
- Registered I/O cells with individually controlled clocks and output enables

Total of 204 I/O Pins

- 196 bidirectional input/output pins, PCI-compliant for 5.0 volt and 3.3 volt buses for -1/-2/-3/-4 speed grades
- 4 high-drive input-only pins
- 4 high-drive input/distributed network pins

Four Low-Skew Distributed Networks

- Two array clock/control networks available to the logic cell flip-flop clock, set and reset inputs - each driven by an input-only pin
- Six global clock/control networks available to the logic cell F1, clock set and reset inputs and the input and I/O register clock, reset and enable inputs as well as the output enable control - each driven by an input-only or I/O pin, or any logic cell output or I/O cell feedback

High Performance

- Input + logic cell + output total delays under 6 ns
- Data path speeds over 400 MHz
- Counter speeds over 300 MHz

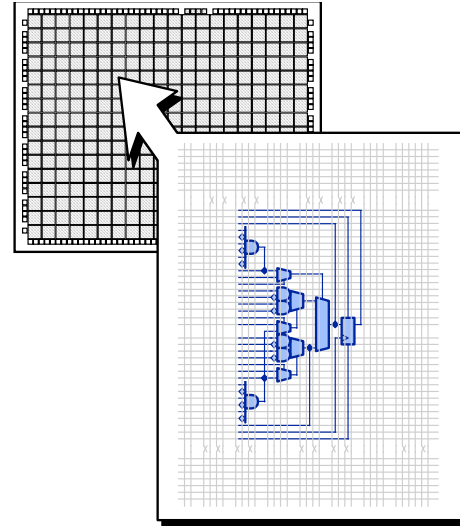


FIGURE 1. 672 Logic Cells

PRODUCT SUMMARY

The QL3025 is a 25,000 usable PLD gate member of the pASIC 3 family of FPGAs. pASIC 3 FPGAs are fabricated on a 0.35µm four-layer metal process using QuickLogic's patented ViaLink technology to provide a unique combination of high performance, high density, low cost, and extreme ease-of-use.

The QL3025 contains 672 logic cells. With a maximum of 204 I/Os, the QL3025 is available in 144-pin TQFP, 208-PQFP, and 256-pin PBGA packages.

Software support for the complete pASIC 3 family, including the QL3025, is available through three basic packages. The turnkey QuickWorks™ package provides the most complete FPGA software solution from design entry to logic synthesis, to place and route, to simulation. The QuickTools™ for Workstations package provides a solution for designers who use Cadence, Exemplar, Mentor, Synopsys, Synplicity, Viewlogic, Veribest, or other third-party tools for design entry, synthesis, or simulation.

QL3025 PINOUT DIAGRAMS

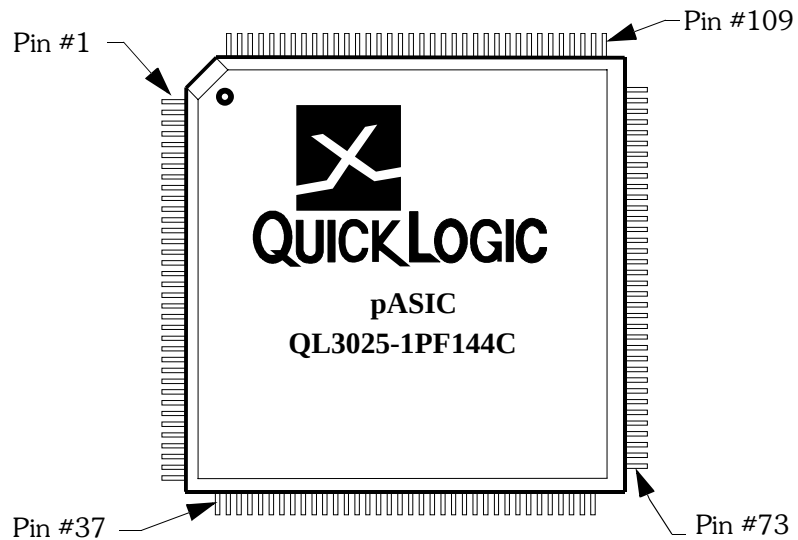


FIGURE 2. 144-Pin TQFP

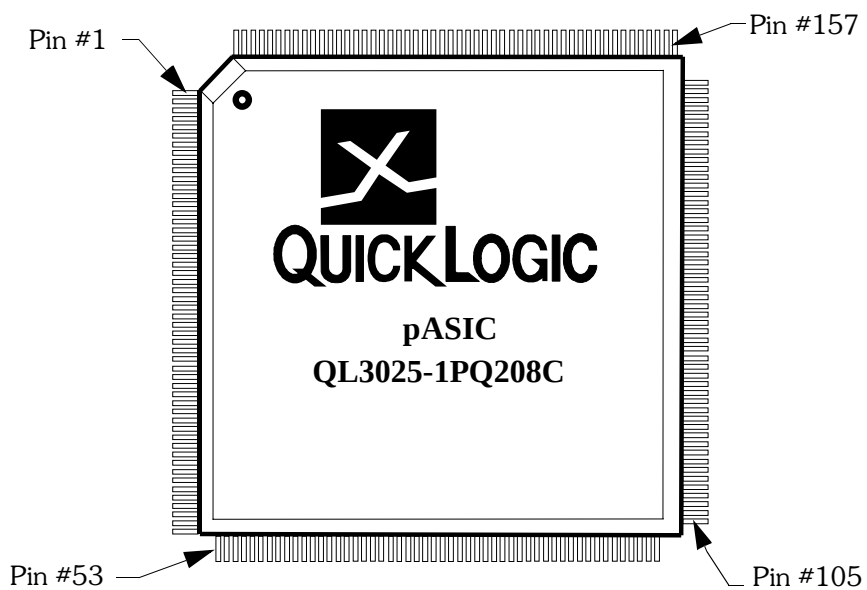


FIGURE 3. 208-Pin PQFP

QL3025 - pASIC 3 FPGA™

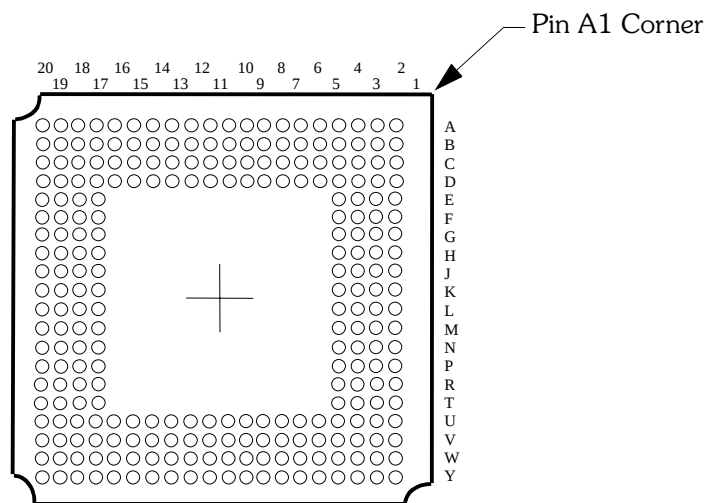
144 TQFP & 208 PQFP PINOUT TABLE

208 PQFP	144 TQFP	Function	208 PQFP	144 TQFP	Function	208 PQFP	144 TQFP	Function	208 PQFP	144 TQFP	Function	208 PQFP	144 TQFP	Function
1	NC	I/O	43	30	GND	85	60	I/O	127	87	GND	169	117	I/O
2	1	I/O	44	31	I/O	86	61	I/O	128	88	I/O	170	118	I/O
3	2	I/O	45	NC	I/O	87	NC	I/O	129	89	I	171	119	I/O
4	3	I/O	46	32	I/O	88	62	I/O	130	90	ACLK / I	172	120	I/O
5	NC	I/O	47	NC	I/O	89	63	I/O	131	91	VCC	173	NC	I/O
6	4	I/O	48	33	I/O	90	NC	I/O	132	92	I	174	NC	I/O
7	5	I/O	49	NC	I/O	91	NC	I/O	133	93	GCLK / I	175	121	I/O
8	NC	I/O	50	34	I/O	92	64	I/O	134	94	VCC	176	NC	I/O
9	6	I/O	51	35	I/O	93	NC	I/O	135	95	I/O	177	122	GND
10	7	VCC	52	36	I/O	94	65	I/O	136	NC	I/O	178	123	I/O
11	NC	I/O	53	37	I/O	95	66	GND	137	96	I/O	179	124	I/O
12	NC	GND	54	38	TDI	96	67	I/O	138	NC	I/O	180	NC	I/O
13	8	I/O	55	39	I/O	97	NC	VCC	139	97	I/O	181	125	I/O
14	NC	I/O	56	NC	I/O	98	NC	I/O	140	98	I/O	182	126	GND
15	9	I/O	57	40	I/O	99	68	I/O	141	NC	I/O	183	127	I/O
16	NC	I/O	58	NC	I/O	100	69	I/O	142	99	I/O	184	128	I/O
17	10	I/O	59	NC	GND	101	NC	I/O	143	NC	I/O	185	129	I/O
18	11	I/O	60	41	I/O	102	70	I/O	144	100	I/O	186	NC	I/O
19	12	I/O	61	42	VCC	103	71	TRSTB	145	NC	VCC	187	130	VCCIO
20	13	I/O	62	43	I/O	104	72	TMS	146	101	I/O	188	131	I/O
21	NC	I/O	63	NC	I/O	105	NC	I/O	147	102	GND	189	132	I/O
22	14	I/O	64	44	I/O	106	73	I/O	148	103	I/O	190	NC	I/O
23	15	GND	65	45	I/O	107	NC	I/O	149	104	I/O	191	133	I/O
24	16	I/O	66	NC	I/O	108	74	I/O	150	NC	I/O	192	134	I/O
25	17	I	67	46	I/O	109	75	I/O	151	105	I/O	193	NC	I/O
26	18	ACLK / I	68	47	I/O	110	76	I/O	152	106	I/O	194	135	I/O
27	19	VCC	69	48	I/O	111	77	I/O	153	NC	I/O	195	136	I/O
28	20	I	70	NC	I/O	112	NC	I/O	154	107	I/O	196	NC	I/O
29	21	GCLK / I	71	49	I/O	113	78	I/O	155	NC	I/O	197	137	I/O
30	22	VCC	72	NC	I/O	114	79	VCC	156	108	I/O	198	NC	I/O
31	23	I/O	73	50	GND	115	80	I/O	157	109	TCK	199	138	GND
32	NC	I/O	74	51	I/O	116	NC	GND	158	110	STM	200	139	I/O
33	24	I/O	75	52	I/O	117	81	I/O	159	111	I/O	201	NC	VCC
34	NC	I/O	76	NC	I/O	118	82	I/O	160	NC	I/O	202	140	I/O
35	25	I/O	77	53	I/O	119	NC	I/O	161	112	I/O	203	NC	I/O
36	NC	I/O	78	54	GND	120	83	I/O	162	113	I/O	204	141	I/O
37	26	I/O	79	55	I/O	121	NC	I/O	163	NC	GND	205	142	I/O
38	27	I/O	80	56	I/O	122	84	I/O	164	NC	I/O	206	NC	I/O
39	28	I/O	81	NC	I/O	123	85	I/O	165	114	VCC	207	143	TDO
40	NC	I/O	82	57	I/O	124	NC	I/O	166	115	I/O	208	144	I/O
41	NC	VCC	83	58	VCCIO	125	86	I/O	167	116	I/O			
42	29	I/O	84	59	I/O	126	NC	I/O	168	NC	I/O			

256-PIN PBGA PINOUT DIAGRAM



TOP



BOTTOM

QL3025 - pASIC 3 FPGA™

PBGA 256 PINOUT TABLE

256 PBGA	Function	256 PBGA	Function	256 PBGA	Function	256 PBGA	Function	256 PBGA	Function	256 PBGA	Function
A1	VSS	C4	I/O	E19	I/O	L2	ACLK / I	T17	I/O	V20	I/O
A2	I/O	C5	I/O	E20	I/O	L3	I	T18	I/O	W1	I/O
A3	I/O	C6	I/O	F1	I/O	L4	GCLK / I	T19	NC	W2	I/O
A4	I/O	C7	I/O	F2	I/O	L17	VCC	T20	I/O	W3	TDI
A5	I/O	C8	I/O	F3	I/O	L18	I/O	U1	I/O	W4	I/O
A6	I/O	C9	VCCIO	F4	VCC	L19	I/O	U2	I/O	W5	I/O
A7	I/O	C10	I/O	F17	VCC	L20	I/O	U3	I/O	W6	I/O
A8	I/O	C11	I/O	F18	NC	M1	I/O	U4	VSS	W7	I/O
A9	I/O	C12	I/O	F19	I/O	M2	I/O	U5	I/O	W8	I/O
A10	I/O	C13	I/O	F20	I/O	M3	I/O	U6	VCC	W9	I/O
A11	I/O	C14	I/O	G1	I/O	M4	NC	U7	I/O	W10	I/O
A12	I/O	C15	I/O	G2	NC	M17	NC	U8	VSS	W11	I/O
A13	I/O	C16	I/O	G3	I/O	M18	I/O	U9	I/O	W12	I/O
A14	I/O	C17	I/O	G4	I/O	M19	I/O	U10	VCC	W13	I/O
A15	I/O	C18	I/O	G17	I/O	M20	I/O	U11	I/O	W14	I/O
A16	I/O	C19	I/O	G18	I/O	N1	I/O	U12	I/O	W15	I/O
A17	I/O	C20	I/O	G19	NC	N2	I/O	U13	VSS	W16	I/O
A18	I/O	D1	I/O	G20	I/O	N3	I/O	U14	I/O	W17	I/O
A19	TCK	D2	I/O	H1	I/O	N4	VSS	U15	VCC	W18	I/O
A20	I/O	D3	I/O	H2	I/O	N17	VSS	U16	I/O	W19	I/O
B1	TDO	D4	VSS	H3	I/O	N18	I/O	U17	VSS	W20	TRSTB
B2	I/O	D5	I/O	H4	VSS	N19	I/O	U18	I/O	Y1	I/O
B3	I/O	D6	VCC	H17	VSS	N20	I/O	U19	I/O	Y2	NC
B4	I/O	D7	I/O	H18	I/O	P1	I/O	U20	I/O	Y3	I/O
B5	I/O	D8	VSS	H19	I/O	P2	I/O	V1	I/O	Y4	I/O
B6	I/O	D9	I/O	H20	I/O	P3	I/O	V2	NC	Y5	I/O
B7	I/O	D10	I/O	J1	I/O	P4	I/O	V3	I/O	Y6	I/O
B8	I/O	D11	VCC	J2	I/O	P17	I/O	V4	I/O	Y7	I/O
B9	I/O	D12	I/O	J3	NC	P18	I/O	V5	I/O	Y8	I/O
B10	I/O	D13	VSS	J4	I/O	P19	NC	V6	I/O	Y9	I/O
B11	I/O	D14	I/O	J17	NC	P20	I/O	V7	I/O	Y10	I/O
B12	I/O	D15	VCC	J18	I/O	R1	NC	V8	I/O	Y11	I/O
B13	I/O	D16	I/O	J19	I/O	R2	I/O	V9	I/O	Y12	I/O
B14	I/O	D17	VSS	J20	GCLK / I	R3	I/O	V10	I/O	Y13	I/O
B15	I/O	D18	I/O	K1	I/O	R4	VCC	V11	I/O	Y14	I/O
B16	I/O	D19	I/O	K2	I/O	R17	VCC	V12	VCCIO	Y15	I/O
B17	NC	D20	I/O	K3	I/O	R18	I/O	V13	I/O	Y16	I/O
B18	STM	E1	NC	K4	VCC	R19	I/O	V14	I/O	Y17	I/O
B19	NC	E2	I/O	K17	I	R20	I/O	V15	I/O	Y18	I/O
B20	I/O	E3	I/O	K18	ACLK / I	T1	NC	V16	I/O	Y19	I/O
C1	I/O	E4	I/O	K19	I	T2	I/O	V17	I/O	Y20	NC
C2	I/O	E17	I/O	K20	NC	T3	I/O	V18	I/O		
C3	I/O	E18	I/O	L1	I	T4	NC	V19	TMS		

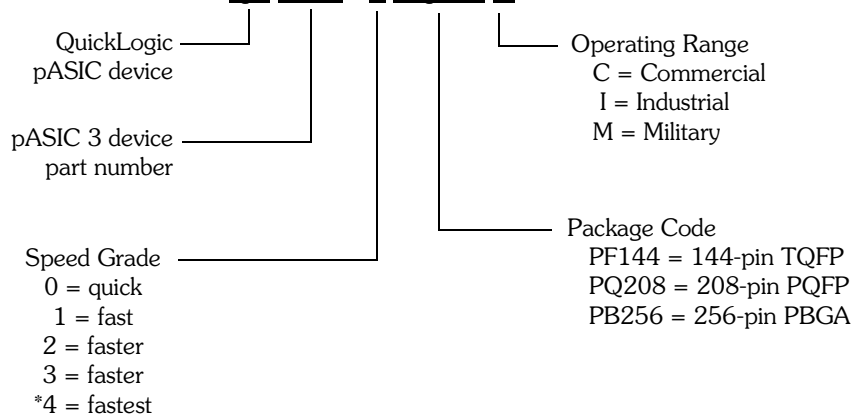
QL3025 - pASIC 3 FPGA™

PIN DESCRIPTIONS

Pin	Function	Description
TDI	Test Data In for JTAG	Hold HIGH during normal operation. Connect to VCC if not used for JTAG.
TRSTB	Active low Reset for JTAG	Hold LOW during normal operation. Connect to ground if not used for JTAG.
TMS	Test Mode Select for JTAG	Hold HIGH during normal operation. Connect to VCC if not used for JTAG.
TCK	Test Clock for JTAG	Hold HIGH or LOW during normal operation. Connect to VCC or ground if not used for JTAG.
TDO	Test data out for JTAG	Output that must be left unconnected if not used for JTAG.
STM	Special Test Mode	Must be grounded during normal operation.
I/ACLK	High-drive input and/or array network driver	Can be configured as either or both.
I/GCLK	High-drive input and/or global network driver	Can be configured as either or both.
I	High-drive input	Use for input signals with high fanout.
I/O	Input/Output pin	Can be configured as an input and/or output.
VCC	Power supply pin	Connect to 3.3V supply.
VCCIO	Input voltage tolerance pin	Connect to 5.0 volt supply if 5 volt input tolerance is required, otherwise connect to 3.3V supply.
GND	Ground pin	Connect to ground.

Ordering Information

QL 3025 - 1 PQ208 C



* Contact QuickLogic regarding availability

QL3025 - pASIC 3 FPGA™

Absolute Maximum Ratings

VCC Voltage	-0.5 to 4.6V	DC Input Current	±20 mA
VCCIO Voltage	-0.5 to 7.0V	ESD Pad Protection	±2000V
Input Voltage	-0.5 to VCCIO +0.5V	Storage Temperature	-65°C to +150°C
Latch-up Immunity	±200 mA	Lead Temperature	300°C

Operating Range

Symbol	Parameter	Military		Industrial		Commercial		Unit
		Min	Max	Min	Max	Min	Max	
VCC	Supply Voltage	3.0	3.6	3.0	3.6	3.0	3.6	V
VCCIO	I/O Input Tolerance Voltage	3.0	5.5	3.0	5.5	3.0	5.25	V
TA	Ambient Temperature	-55		-40	85	0	70	°C
TC	Case Temperature		125					°C
K	Delay Factor	-0 Speed Grade		0.43	1.90	0.46	1.85	
		-1 Speed Grade		0.42	1.64	0.43	1.54	
		-2 Speed Grade		0.42	1.37	0.43	1.28	
		-3 Speed Grade		N/A	N/A	0.43	0.90	
		-4 Speed Grade		N/A	N/A	0.43	0.82	

DC Characteristics

Symbol	Parameter	Conditions	Min	Max	Unit
VIH	Input HIGH Voltage		0.5VCC	VCCIO+0.5	V
VIL	Input LOW Voltage		-0.5	0.3VCC	V
VOH	Output HIGH Voltage	IOH = -12 mA	2.4		V
		IOH = -500 µA	0.9VCC		V
VOL	Output LOW Voltage	IOL = 16 mA [1]		0.45	V
		IOL = 1.5 mA		0.1VCC	V
II	I or I/O Input Leakage Current	VI = VCCIO or GND	-10	10	µA
IOZ	3-State Output Leakage Current	VI = VCCIO or GND	-10	10	µA
CI	Input Capacitance [2]			10	pF
IOS	Output Short Circuit Current [3]	VO = GND	-15	-180	mA
		VO = VCC	40	210	mA
ICC	D.C. Supply Current [4]	VI, VIO = VCCIO or GND	0.50 (typ)	2	mA
ICCIO	D.C. Supply Current on VCCIO		0	100	µA

Notes:

- [1] Applies only to -1/-2/-3/-4 commercial grade devices. These speed grades are also PCI-compliant. All other devices have 8 mA IOL specifications.
- [2] Capacitance is sample tested only. Clock pins are 12 pF maximum.
- [3] Only one output at a time. Duration should not exceed 30 seconds.
- [4] For -1/-2/-3/-4 commercial grade devices only. Maximum ICC is 3 mA for -0 commercial grade and all industrial grade devices, and 5 mA for all military grade devices. For AC conditions, contact QuickLogic customer engineering.

AC Characteristics at VCC = 3.3V, TA = 25°C (K = 1.00)

(To calculate delays, multiply the appropriate K factor in the "Operating Range" section by the following numbers.)

Logic Cells

Symbol	Parameter	Propagation Delays (ns) Fanout [5]				
		1	2	3	4	8
tPD	Combinatorial Delay [6]	1.4	1.7	1.9	2.2	3.2
tSU	Setup Time [6]	1.7	1.7	1.7	1.7	1.7
tH	Hold Time	0.0	0.0	0.0	0.0	0.0
tCLK	Clock to Q Delay	0.7	1.0	1.2	1.5	2.5
tCWHI	Clock High Time	1.2	1.2	1.2	1.2	1.2
tCWLO	Clock Low Time	1.2	1.2	1.2	1.2	1.2
tSET	Set Delay	1.0	1.3	1.5	1.8	2.8
tRESET	Reset Delay	0.8	1.1	1.3	1.6	2.6
tSW	Set Width	1.9	1.9	1.9	1.9	1.9
tRW	Reset Width	1.8	1.8	1.8	1.8	1.8

Input-Only/Clock Cells

Symbol	Parameter	Propagation Delays (ns) Fanout [5]						
		1	2	3	4	8	12	24
tIN	High Drive Input Delay	1.5	1.6	1.8	1.9	2.4	2.9	4.4
tINI	High Drive Input, Inverting Delay	1.6	1.7	1.9	2.0	2.5	3.0	4.5
tISU	Input Register Set-Up Time	3.1	3.1	3.1	3.1	3.1	3.1	3.1
tIH	Input Register Hold Time	0.0	0.0	0.0	0.0	0.0	0.0	0.0
tICLK	Input Register Clock To Q	0.7	0.8	1.0	1.1	1.6	2.1	3.6
tIRST	Input Register Reset Delay	0.6	0.7	0.9	1.0	1.5	2.0	3.5
tIESU	Input Register clock Enable Set-Up Time	2.3	2.3	2.3	2.3	2.3	2.3	2.3
tIEH	Input Register Clock Enable Hold Time	0.0	0.0	0.0	0.0	0.0	0.0	0.0

Notes:

[5] Stated timing for worst case Propagation Delay over process variation at VCC=3.3V and TA=25°C. Multiply by the appropriate Delay Factor, K, for speed grade, voltage and temperature settings as specified in the Operating Range.

[6] These limits are derived from a representative selection of the slowest paths through the pASIC 3 logic cell including typical net delays. Worst case delay values for specific paths should be determined from timing analysis of your particular design.

QL3025 - pASIC 3 FPGA™

Clock Cells

Symbol	Parameter	Propagation Delays (ns) Loads per Half Column [7]						
		1	2	3	4	8	10	11
tACK	Array Clock Delay	1.2	1.2	1.3	1.3	1.5	1.6	1.7
tGCKP	Global Clock Pin Delay	0.7	0.7	0.7	0.7	0.7	0.7	0.7
tGCKB	Global Clock Buffer Delay	0.8	0.8	0.9	0.9	1.1	1.2	1.3

I/O Cells

Symbol	Parameter	Propagation Delays (ns) Fanout [5]					
		1	2	3	4	8	10
tI/O	Input Delay (bidirectional pad)	1.3	1.6	1.8	2.1	3.1	3.6
tISU	Input Register Set-Up Time	3.1	3.1	3.1	3.1	3.1	3.1
tIH	Input Register Hold Time	0.0	0.0	0.0	0.0	0.0	0.0
tIOCLK	Input Register Clock To Q	0.7	1.0	1.2	1.5	2.5	3.0
tIORST	Input Register Reset Delay	0.6	0.9	1.1	1.4	2.4	2.9
tIESU	Input Register clock Enable Set-Up Time	2.3	2.3	2.3	2.3	2.3	2.3
tIEH	Input Register Clock Enable Hold Time	0.0	0.0	0.0	0.0	0.0	0.0

Symbol	Parameter	Propagation Delays (ns) Output Load Capacitance (pF)				
		30	50	75	100	150
tOUTLH	Output Delay Low to High	2.1	2.5	3.1	3.6	4.7
tOUTH	Output Delay High to Low	2.2	2.6	3.2	3.7	4.8
tPZH	Output Delay Tri-state to High	1.2	1.7	2.2	2.8	3.9
tPZL	Output Delay Tri-state to Low	1.6	2.0	2.6	3.1	4.2
tPHZ	Output Delay High to Tri-State [8]	2.0				
tPLZ	Output Delay Low to Tri-State [8]	1.2				

Notes:

[7] The array distributed networks consist of 40 half columns and the global distributed networks consist of 44 half columns, each driven by an independent buffer. The number of half columns used does not affect clock buffer delay. The array clock has up to 8 loads per half column. The global clock has up to 11 loads per half column.

[8] The following loads are used for tPXZ:

